TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC7W126FU**

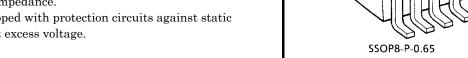
#### **Dual BUS Buffer**

The TC7W126FU is a high speed C<sup>2</sup>MOS Dual BUS Buffers fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the C<sup>2</sup>MOS low power dissipation.

The require 3-state control input G to be set low to place the output into the high impedance.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.



Weight: 0.02 g (typ.)

#### **Features**

- High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max)}$  at  $T_a = 25^{\circ}C$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 6 mA (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V

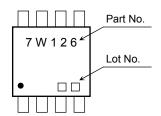
#### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{CC} + 0.5$	V
Input diode current	l <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V <sub>CC</sub> /ground current	Icc	±37.5	mA
Power dissipation	PD	300	mW
Storage temperature range	T <sub>stg</sub>	-65 to 150	°C
Lead temperature (10 s)	TL	260	°C

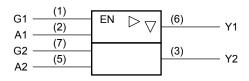
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

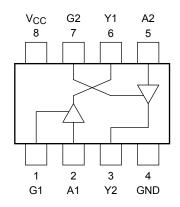
## Marking



# **Logic Diagram**



# Pin Configuration (top view)



## **Truth Table**

Inp	Output			
G	Α	Y		
L	Х	Z		
Н	L	L		
Н	Н	Н		

X: Don't care

Z: High impedance

# **Operating Ranges**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	<b>V</b>
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	<b>V</b>
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

## **Electrical Characteristics**

#### **DC Electrical Characteristics**

Characteristics Symbol Test Condition		Svmbol	Test Condition		_	Ta = 25°C			Ta = -40 to 85°C		Unit
		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max				
					2.0	1.5	_	_	1.5	_	
	High level	V <sub>IH</sub>	_		4.5	3.15	_	_	3.15		
Input voltage					6.0	4.2	_	_	4.2	_	V
input voitage							_	0.5	_	0.5	ľ
	Low level	$V_{IL}$		_	4.5	_	_	1.35	_	1.35	
					6.0		_	1.8	_	1.8	
			V <sub>IN</sub> = V <sub>IH</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	1.9	_	V
	High level	V <sub>ОН</sub>			4.5	4.4	4.5	_	4.4		
					6.0	5.9	6.0	_	5.9		
				$I_{OH} = -6 \text{ mA}$	4.5	4.18	4.31	_	4.13	_	
Output				$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
voltage	Low level	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 20 μA	2.0		0	0.1	_	0.1	
					4.5	_	0	0.1	_	0.1	
					6.0	_	0	0.1	_	0.1	
				$I_{OL} = 6 \text{ mA}$	4.5	_	0.17	0.26	_	0.33	
				$I_{OL} = 7.8 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
3-state output off-state current $I_{OZ}$ $V_{IN} = V_{IH}$ or $V_{IL}$ $V_{OUT} = V_{CC}$ or GND		6.0		_	±0.5	_	±5.0	μА			
Input leakage of	Input leakage current $I_{IN}$ $V_{IN} = V_{CC}$ or GND		6.0	_		±0.1	_	±1.0	μА		
Quiescent supply current I <sub>CC</sub> V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	2.0	_	20.0	μА			

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#### AC Electrical Characteristics (input $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition			Ta = 25°C		:	Ta = -40 to 85°C		Unit	
	,		$C_L$	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max		
	t <sub>TLH</sub>	_	50	2.0	_	20	60	_	75	ns	
Output transition time				4.5		6	12	_	15		
	-1112			6.0		5	10	_	13		
			50	2.0		30	90	_	115		
				4.5		11	18	_	23		
Propagation delay time	t <sub>pLH</sub>			6.0		10	15	_	20	ns	
Tropagation delay time	t <sub>pHL</sub>	_	150	2.0		42	130	_	165	- ris	
				4.5		14	26	_	33		
				6.0		12	22	_	28		
	<sup>t</sup> pZL <sup>t</sup> pZH	$R_L = 1 \text{ k}\Omega$	50	2.0		30	90	_	115	- ns	
				4.5		11	18	_	23		
Output enable time				6.0		10	15	_	20		
Output enable time			150	2.0		42	130	_	165		
				4.5		14	26	_	33		
				6.0	_	12	22	_	28		
	t <sub>pLZ</sub> F	$R_L = 1 \text{ k}\Omega$	50	2.0	_	24	100	_	125	ns	
Output disable time				4.5	_	12	20	_	25		
				6.0	_	10	17	_	21		
Input capacitance	C <sub>IN</sub>	_		_		5	10	_	10	pF	
Output capacitance	C <sub>OUT</sub>	_	_	_	_	10	_	_	_	pF	
Power dissipation capacitance	C <sub>PD</sub>	(Note)	_	_	_	32	_	_	_	pF	

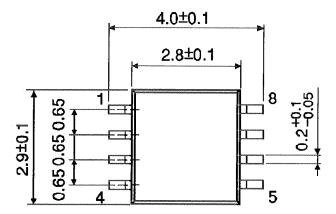
Note: C<sub>PD</sub> is defined as the value of internal equivalent capacitance which is calculated from the operating current consumption without load.

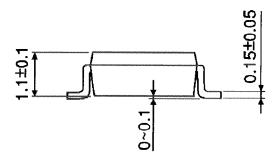
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per gate)}$ 

# **Package Dimensions**

SSOP8-P-0.65 Unit: mm





Weight: 0.02 g (typ.)

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